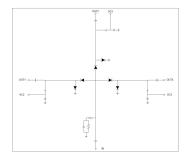


GaAs PIN reflective single-pole triple-throw switch chip, 10-40GHz

Performance characteristics

- Frequency range: 10-40 GHz
- Insertion loss : 0.7dB typ.
- Isolation: 41 dB typ.
- P-1dB: 25dBm @17GHz
- 500hm input / output
- 100% on-wafer testing
- Chip size: 1.92 x 1.57 x 0.1mm
- Silicon nitride passivation, scratch protection

Functional Block Diagram



Product Introduction

GSW3B2 is a GaAs PIN reflective single-pole triple-throw switch chip with 50Ω matching at the input/output ends, a frequency range of 10 to 40GHz, and -5V/+5V control. It has a built-in bias network and DC blocking capacitors, which is easy to use. It has excellent switching characteristics and port standing wave characteristics in the entire operating frequency range, and is very suitable for microwave hybrid integrated circuits, multi-chip modules, and low-power systems. The switch chip uses on-chip through-hole metallization technology to ensure good grounding, does not require additional grounding measures, and is simple and convenient to use. The back of the chip is metallized, which is suitable for eutectic sintering or conductive adhesive bonding processes.

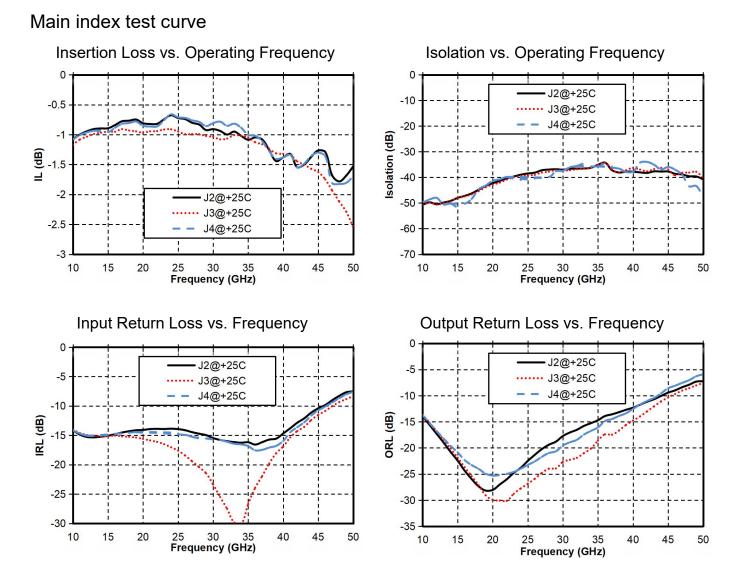
Use restriction parameter ¹

Maximum input voltage	2 5V
Maximum input power	+31dBm CW
Operating temperature	-55 ~ +85°C
storage temperature	-65 ~ +150°C

 $\begin{bmatrix} 1 \end{bmatrix}$ Exceeding any of these maximum limits may cause permanent damage.

Electrical performance parameters (TA = $+25^{\circ}$ C)				
index	Minimum	Typical Value	Maximum	unit
Frequency Range		10-40		GHz
Insertion loss	-	0.7	1.4	dB
Isolation	37	41	-	dB
Input return loss	14	15	-	dB
Output return loss	12	19	-	dB
P-1dB @17GHz	-	25	-	dBm
Switching speed	-	20	-	ns

GaAs PIN reflective single-pole triple-throw switch chip, 10-40GHz



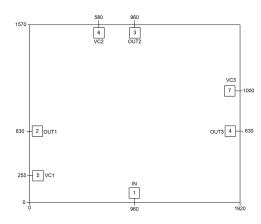
Typical Driver Connections

CONTROL LEVEL (DC CURRENT)		RF OUTPUT STATE			
VC1	VC2	VC3	OUT1(J2)-IN(J1)	OUT2(J3)-IN(J1)	OUT3(J4)-IN(J1)
-10mA	+1 2 mA	+1 2 mA	Low Loss	Isolation	Isolation
+1 2 mA	-10mA	+1 2 mA	Isolation	Low Loss	Isolation
+1 2 mA	+1 2 mA	-10mA	Isolation	Isolation	Low Loss
Note: V ≈ +1.32 V , I ≈ +12 mA; V ≈ -1.90 V, I ≈ -10 mA (including RIN ≈ 50 ohm resistor voltage divider					
at J1)					



GaAs PIN reflective single-pole triple-throw switch chip, 10-40GHz

Appearance structure

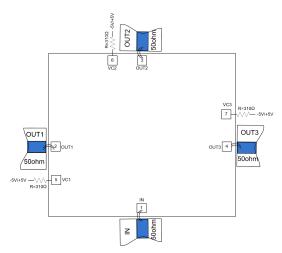


All units in the figure are micrometers

Bonding point definition

Bonding point number	Function Symbol	Functional Description	
1	IN(J1)	RF input signal terminal	
2, 3, 4	OUT1(J2), OUT2(J3), OUT3(J4)	RF output signal terminal	
5, 6, 7	VC1, VC2, VC3	Signal control port	
Chip bottom	GND	The bottom of the chip needs to be well	
		grounded to RF and DC	

Recommended circuit diagram



+5V series R≈310 ohm resistor, V≈+1.32V , I≈+12mA ; -5V series R≈310 ohm resistor, V≈-1.90V , I≈-10mA . Users can change the resistance value according to their own situation. If you have any questions, please contact the manufacturer.